TR-72G

RF Transceiver Module Series

Data Sheet

Preliminary





Description

TR-72G is a family of IQRF transceiver modules operating in the 868 MHz and 916 MHz license free ISM (Industry, Scientific and Medical) frequency band. Its highly integrated ready-to-use design containing MCU, RF circuitry, integrated LDO regulator, serial EEPROM, optional temperature sensor and optional on-board antenna requires no external components. Ultra low power consumption fits for battery powered applications. Flexible MCU pins enable extended functionality and simpler application circuitry and PCB. Extended MCU memories include built-in operating system which significantly reduces application development time. Optional DPA framework supports applications even without programming.



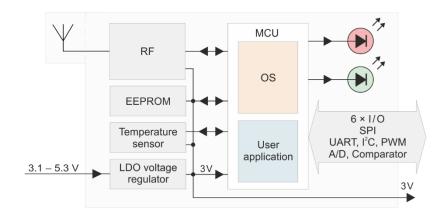
- Operating system (upgradeable at the user), easy to use
- DPA framework for Mesh network applications
- GFSK modulation
- Selectable RF band 868 / 916 MHz, multiple channel
- RF output power 10 mW (10 dBm) with antenna connector
- Eff. radiated power 1.6 mW (2 dBm) with on-board antenna
- MCU with significantly extended memories for program and data
- Extended MCU resources (interrupt capability and programmable internal pull-ups on all pins, remappable digital peripherals, ...)
- Extra low power consumption, power management modes
- SPI interface supported by OS in background
- Serial EEPROM 256 Kb
- Multiple PWM output
- Extended programmable HW timer options
- +3 V LDO regulator output, battery monitoring
- 2 LEDs
- 8 pins, 6 I/Os
- A/D converter (multiple channels) and analog comparator
- Options: on-board antenna, U.FL connector, temperature sensor
- SIM card format fits KON-SIM-02 and KON-SIM-01 connectors
- Shielding can
- Small dimensions

Block diagram



Applications

- Bidirectional RF communication
- Point-to-point or network wireless connectivity
- Telemetry, AMR (automatic meter reading)
- WSN (wireless sensor network)
- Building automation
- Street lighting control
- Wireless monitoring, control and regulation
- Remote data acquisition
- RF connectivity in many other fields
- Also for municipal and indoor areas
- Internet of Things





The information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets your specifications.

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Technical specifications

Typical values unless otherwise stated

Parameters specified in this datasheet are typical values. They are at power supply $V_{OUT} = 3 V$ only. V_{OUT} voltage different from 3 V can impact on RF range and other parameters.

Supply voltage (V _{CC}) LDO output (V _{OUT})	3.1 V to 5.3 V +3 V ± 60 mV (V _{CC} > 3.1 V), 100 mA max.
Operating temperature ¹	-40 °C to +85 °C
Supply current	
Deep sleep mode Sleep mode	< 2 μ A (All peripherals disabled ³ , RF IC in Standby mode) 2.3 μ A (all peripherals disabled ³ , RF IC in Sleep mode)
Run mode RF sleep RF ready	1.8 mA 3.3 mA
RX mode STD LP ⁴ XLP ⁴	12.5 mA 190 μA 13 μA
TX mode	8 mA – 25 mA (according to RF output power)
Additional LED supply current	About 2 mA per LED. Rough value for brief guidance only.
RF band RF channels RF data modulation RF data transmission bit rate	868 MHz or 916 MHz (software configurable) See IQRF OS User's guide, Appendix <i>Channel maps</i> GFSK (Gaussian Frequency Shift Keying) 19.8 kb/s
RF receiver category RF sensitivity	1.5 (according to ETSI EN 300 220-1 V3.1.1) -103 dBm ^{5A} , -94 dBm ^{5B} , (STD RX mode, checkRF(0)). See <i>Diagram 3</i> .
RF output power ^{5A} Effective radiated power ^{2, 5B} RF interface ^{5A}	Up to 10 dBm (for 50 Ω load), programmable in 8 levels (0 – 7). Up to 2.0 dBm (868 MHz band), 0.0 to 2.0 dBm (916 MHz band). See <i>Table 1</i> . Single-ended, output impedance 50 Ω
Antenna ^{5B} RF range ^{2, 5B}	PCB meander line, linear polarization, omnidirectional. See <i>Diagram 1</i> . 500 m
Input voltage on C1, C2, C5 to C8 pins	0 V to V _{OUT}
A/D converter	10 bit, multiple inputs. Refer to MCU datasheet.
Temperature sensor	MCP9808E/MC (for TR types with 'T' postfix only, e.g. TR-76GT)
Size (L x W x H)	25.1 mm x 14.9 mm x 3.3 mm ^{6A} 31.8 mm x 14.9 mm x 3.3 mm ^{6B}
Storage environment	Temperature +16 °C to +24 °C, relative humidity 65 % max., chemically indifferent

Note 1: RF range may change with lower temperature. Frost, condensation, or humidity over 85% may disable module functionality. Transceiver suitability should be tested in the final application under real conditions before volume use.

Note 2: Arrangement: Two TR-72GA transceivers plugged directly in DK-EVAL-04A kits, vertically, 1.6 m above the ground, in free space, bidirectional communication.

Test software: E16-RANGE-TEST example (STD mode, setRFpower(7), checkRF(5), Preamble Quality Test active).

Note 3: Additional current is consumed when a peripheral (e.g. watchdog, Brown-out detection, etc.) is enabled.

Note 4: Depends on interferences.

Note 5: 5A: For TR types without a built-in antenna.

5B: For TR types with built-in antenna.



Absolute maximum ratings

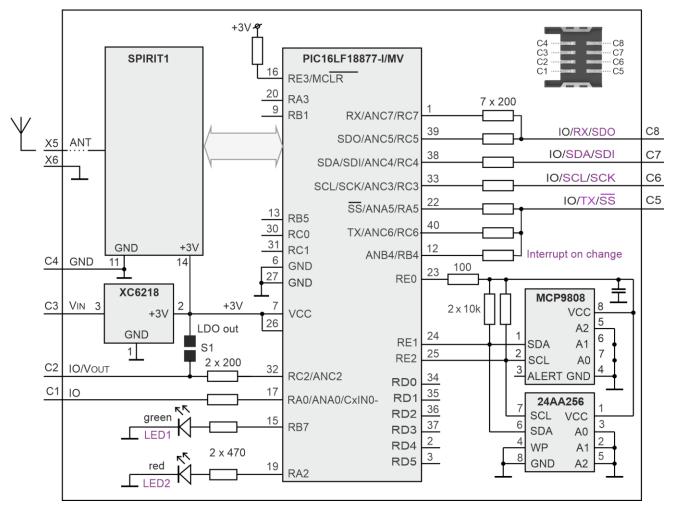
Stresses above listed maximum values may cause permanent damage to the device and affect device reliability. Functional operation under these or any other conditions beyond those specified is not supported.

Supply voltage (V_{CC}) Voltage on C1, C2, C5 to C8 pins (configured as inputs) vs. GND Storage temperature Ambient temperature under bias 5.5 V -0.3 V to (V_{OUT} + 0.3 V) -40 °C to +85 °C -40 °C to +85 °C

Caution: Electrostatic sensitive device. Observe appropriate precautions for handling.

See the application note AN015 - IQRF HW design.

Simplified circuit diagram



Digital peripherals marked in purple are used by IQRF OS and DPA. Therefore, they must not be remapped by PPS.

Basic components

IC	Туре	Manufacturer	Note
MCU	PIC16LF18877-I/MV	Microchip	
RF IC	SPIRIT1	STMicroelectronics	
RF balun	BALF-SPI-01D3	STMicroelectronics	
LDO voltage regulator	XC6218	Torex Semiconductor	
Temperature sensor	MCP9808E/MC	Microchip	For types with 'T' postfix only, e.g. TR-72GT
EEPROM	24AA256-I/CS16K	Microchip	256 Kb



Preliminary

Pin	Name	Description			
C1	IO / C-IN RA0 ANA0 CxIN0-	General I/O pin Interconnect to enable Analog A/D input LDO out Comparator –input P2 C1 C5			
C2	IO/VOUT RC2 ANC2 VOUT	Comparator –inputP2C1C5General I/O pin (if S1 disconnected) Analog A/D input On-board +3 V LDO output (if S1 connected)P3C2C6P4C3P1C7X5•			
C3	VIN	Power supply voltage			
C4	GND	Ground P5 C4 C8 M1 M2			
C5	IO/TX/-SS RA5 -SS ANA5	General I/O pin, SPI Slave select Analog A/D input Bottom view			
	RB4	General I/O pin Interrupt / Wake-up on change (IOC) supported by IQRF OS and DPA. RFPGM / (X)LP mode termination.			
	RC6 TX ANC6	General I/O pin UART TX Analog A/D input			
C6	IO/SCK/SCL RC3 SCK SCL ANC3	General I/O pin SPI clock input I ² C clock Analog A/D input			
C7 ¹	IO/SDI/SDA RC4 SDI SDA ANC7	General I/O pin. SPI data I ² C data Analog A/D input			
C81	IO/RX/SDO RC5 SDO ANC5	General I/O pin. SPI data out Analog A/D input			
	RC7 RX ANC7	General I/O pin UART RX Analog A/D input			
X5	ANT	Antenna input			
P1–P5	5	For manufacturer only			
S1 LDO output enable. Interconnect both S1 page		LDO output enable. Interconnect both S1 pads to enable. Default (from the factory) disabled.			
M1, M	2	Holes for possible mechanical fixation			

All MCU pins connected to TR I/O pins (C1, C2, C5. C6, C7, and C8) are equipped with the interrupt on change capability and programmable pull-up resistor and can be used as analog inputs for A/D converter.

All MCU pins dedicated to internal digital peripherals (e.g. UART, I²C, SPI, PWM, timers, analog comparator output, etc.) are remappable in SW. See the MCU datasheet, chapter *Peripheral Pin Select* (PPS). The list above denotes only the pins assigned to UART, I2C, and SPI by default. Other remappable peripherals (e.g. PWM or analog comparator output) are not denoted there.

Note 1: Pin C8 is used as output and pin C7 as input during the initial approximately 200 ms boot-up (after TR reset) to detect a possible request to enter the programming mode (PGM - wired upload via SPI). After reset, the OS generates a determinate sequence on the C8 pin. If this sequence is copied to the C7, the OS jumps to the PGM bootloader. (The PGM mode is indicated by short red LED flashing every 2 s.)

This must be taken into account to avoid collisions with application circuitry connected to these pins.

The C7 pin must not be interconnected to C8 or left unconnected or without a **defined level** on its input. This level must be arranged **by application hardware**. If the application circuitry ensures no such level, a **pull-down resistor on the C7 pin** must be used otherwise a **cross-talk** between C8 and C7 may cause an unintentional switching to PGM.

C7 SDI C8 SDO 4k7

See the application note AN015 - IQRF HW design.



RF range

RF range strongly depends on the following design aspects:

- Hardware:
 - Construction of the devices (especially TR location within the device, PCB layout, ground planes, conductive areas, and bulk objects such as metallic parts and batteries in the nearest surroundings, with respect to possible reflections and counterpoise effect). To achieve an efficient range and reliable connectivity, no parts impacting the range must be placed close to the built-in meander antenna. Even non-conductive parts including a mainboard PCB under the antenna can significantly impact the range.
 - The physical arrangement of devices (especially mutual orientations of antennas with respect to polarization and radiation patterns)
- Application software:
 - RF output power is selectable from 8 levels
 - To increase immunity to RF noise, incoming RF signals can be filtered according to signal strength.

Refer to IQRF OS Reference guide, function checkRF, and Application note AN014 - RF range.

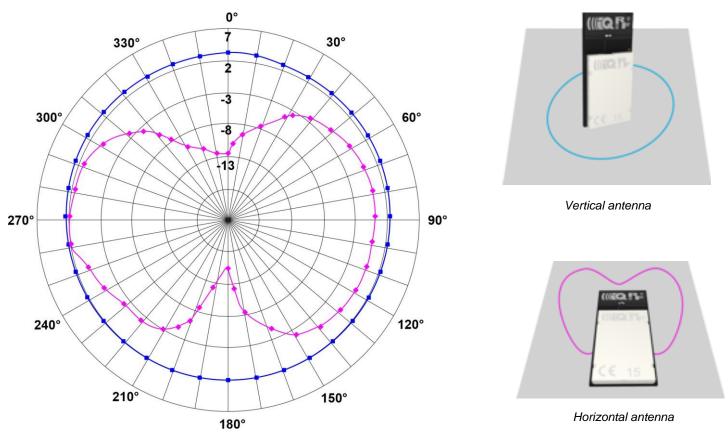
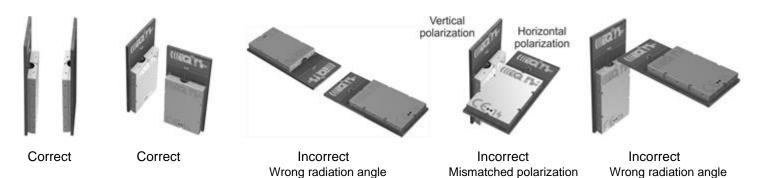


Diagram 1: TR-7xGA RF output power [in dBm] vs. antenna orientation (radiation patterns).

Examples of the correct and incorrect arrangement of TR-72GA pairs:



Mismatched polarization

The **Effective radiated power** (ERP) in the 868 MHz band is constant for all channels. The ERP in the 916 MHz band decreases to higher channels. The ERP drop on channel 255 relative to the power on channel 0 is 2 dBm.

	ERP [dBm]				
level	868 MHz	868 MHz 916 MHz			
	Channels 0 to 67	Channel 0	Channel 104	Channel 255	
7	2	2	1	0	
6	-1	-1	-2	-3	
5	-6	-6	-7	-8	
4	-10	-10	-11	-12	
3	-16	-16	-17	-18	
2	-22	-22	-23	-24	
1	-34	-34	-35	-36	
0	-42	-42	-43	-44	

 Table 1: TR-72GA effective radiated power (ERP) vs. level in the setRFpower (level) function.

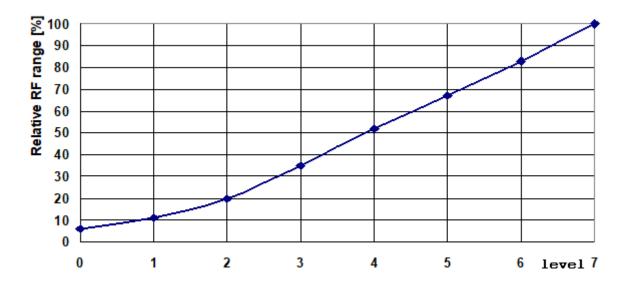


Diagram 2: TR-72G(A) relative RF range vs. level in the setRFpower (level) function.

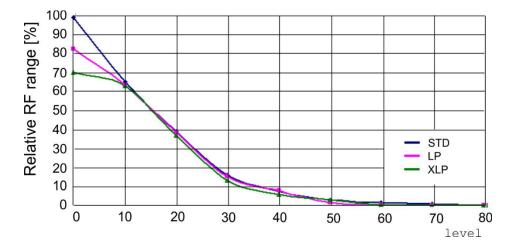


Diagram 3: Relative RF range vs. level in the checkRF (level) function in STD, LP, and XLP RX modes.

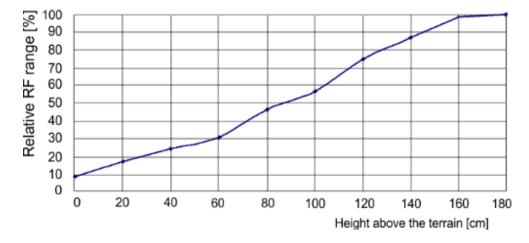
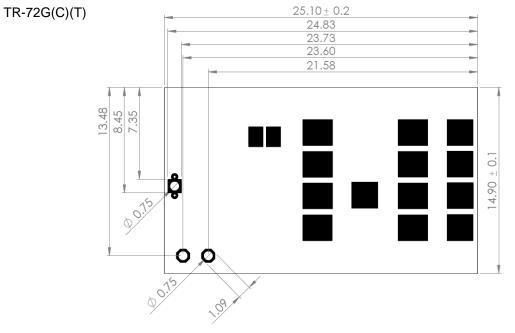


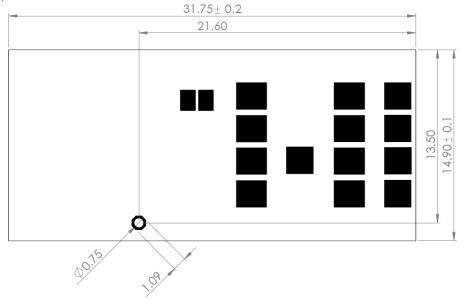
Diagram 4: TR-72GA relative RF range vs. antenna height above the ground, 868 MHz and 916 MHz bands.



Mechanical drawings



TR-72GA(T)



Top view, Units: mm

Hardware revision

TR-72GA v2.01 First release.



Application

Users have to ensure observing local provisions and restrictions relating to the use of short-range devices **by software**, e.g. the CEPT ERC/REC 70-03 Recommendation and subsequent amendments in EU.

See the IQRF video tutorial set and the Application note AN015 - IQRF HW design.

Assembly

TR-72Gx modules should be mounted in the SIM connector. They are not intended for SMT reflow soldering. Recommended SIM connector: KON-SIM-02 or KON-SIM-01.

It is not allowed to connect wires to pads (except the M1, M2, and S1 pads) by soldering.

Sealing

In case of sealing or protecting TR modules against a harsh environment by coating, encapsulating, or potting using a lacquer, gel, or other filling matter, refer to the Application note AN015 - IQRF HW design, chapter Sealing.

Operating system

See IQRF OS User's guide and IQRF OS Reference guide.

DPA framework

See DPA Framework technical guide.

Application software

See IQRF Quick start guide and IQRF application examples.

Programming (upload)

There are the following possibilities to upload an application program in TR-72Gx modules:

- Wired upload with TR-72Gx plugged via the SIM connector in the CK-USB-04(A) programmer.
- For TR-72Gx modules populated in an application:
- · Wired upload
 - Using the CK-USB-04A programmer. See the CK-USB-04A User's guide.
 - Using the CK-USB-04 programmer and the KON-TR-01P adapter. See the KON-TR-01P User's guide.
 - Completely arranged by the user application. See the IQRF SPI Technical guide, chapter Programming mode.
- Wireless upload: See the IQRF OS User's guide, Appendix RFPGM RF programming[™].



Product information

Ordering codes

<u>TR-72G A P</u>			
Peripheral options			
<i>nil</i> - No other option			
T - Temperature sensor			
Antenna options			
nil - soldering pad-hole (no antenna, no U.FL connector)			
A - PCB antenna			
C - U.FL connector (mini-coax)			
Transceiver series			

Туре	Antenna connection	Temperature sensor	Туре	Antenna connection	Temperature sensor
TR-72G	Soldering pad-hole	-	TR-72GT	Soldering pad-hole	Yes
TR-72GC	U.FL connector	_	TR-72GCT	U.FL connector	Yes
TR-72GA	PCB antenna	_	TR-72GAT	PCB antenna	Yes



TR-72G



TR-72GC



TR-72GA





Document history

221118 Bug in *Table 1* fixed.

220718 Preliminary release.



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